IPC ASSOCIATION CO ELECTRONICS IN	© Copyright 2005. IF	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.		ander both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi				Materials and I	Mfg Informati	on		
upplier Iı	nformation													
Company name* Company			Company un	pany unique ID			Unique ID Authority			Respo	Response Date*			
ısemi											2024-04-25			
ontact Nam	ne	Title - Contact			P	Phone - Contact*			Email	Email - Contact*				
roduct-Env	y-Stewards		Product Enviro Compliance			N	NA			Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			P	Phone - Representative*			Email	Email - Representative*			
Product-Env-Stewards Produ				roduct Enviro Compliance			NA			Produ	Product-Env-Stewards@onsemi.com			
R	Requester Item Number		Mfr Item Number Mfr Item Name				Effective Date	Version	Manufacturing S	ite	Weight*	UOM	Unit Type	
		AR02340 A0-MV-0	CSSC28SUK CP	2MP 1/3 CIS SO		2	2024-04-25		TWU		82.3612	mg	Each	
lanufactu	iring Proccess Informat	ion												
Te	Terminal Plating / Grid Array Material Ter			Terminal Base Alloy J-STD-020 MSI		Rating	Peak Process Body Temperature Max Time at Pea		t Peak Temper	k Temperature Number of Reflow Cycles				
SnAgCu		C	CU Alloy 4		4		245	С	30	seco	onds 3			
						-						-	-	

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybrominated Biphenyls (Pl	aterial for Cadmium and quantity limit of 0.1% by BB), Polybrominated Diphenyl Ethers (PBDE), an								
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier shave provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per	the definition above except for defined Ro	oHS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	19.54	mg	Supplier	Silicon (Si)	7440-21-3		19.54	mg
Glass Attach Epoxy	0.0012	mg	Supplier	Imidazole	288-32-4		0.0003	mg
			Supplier	Epoxy Phenol Novolak Resin	28064-14-4		0.0009	mg
Glass Lid /Cap	54.35	mg	Supplier	Glass	65977-17-3		54.35	mg
Insulating Layer	5.51	mg	Supplier	9-Phenylacridine	602-56-2		0.2755	mg
			Supplier	2-Propenoic acid	1245638-61-2		1.653	mg
			Supplier	Other Additive Agents	Proprietary Data		3.306	mg
			Supplier	Butylglycol Acetate	112-07-2		0.2755	mg
Passivation	1.22	mg		Epoxy resin	proprietary data		0.0183	mg
			Supplier	Coupling Agent	Proprietary Data		0.0244	mg
			Supplier	Modified SBR Rubber	Proprietary Data		0.0061	mg
			Supplier	Melamine Compound	Proprietary Data		0.0366	mg
			Supplier	Trispenol Compound	Proprietary Data		0.0366	mg
			Supplier	Photosensitizer	Proprietary Data		0.0976	mg
			Supplier	Hydroxystyrene Resin	Proprietary Data		0.2684	mg
			Supplier	Ethyl Lactate	97-64-3		0.732	mg
RDL	0.82	mg	В	Nickel (Ni)	7440-02-0		0.492	mg
			Supplier	Gold (Au)	7440-57-5		0.0082	mg
			Supplier	Copper (Cu)	7440-50-8		0.3198	mg
Solder Ball	0.92	mg	Supplier	Silver (Ag)	7440-22-4		0.0611	mg
			Supplier	Tin (Sn)	7440-31-5		0.8181	mg
			Supplier	Copper (Cu)	7440-50-8		0.0408	mg